Lattice Semiconductor Corporation - <u>LFEC10E-3Q208C Datasheet</u>



Welcome to **E-XFL.COM**

Understanding <u>Embedded - FPGAs (Field Programmable Gate Array)</u>

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	-
Number of Logic Elements/Cells	10200
Total RAM Bits	282624
Number of I/O	147
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	208-BFQFP
Supplier Device Package	208-PQFP (28x28)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfec10e-3q208c

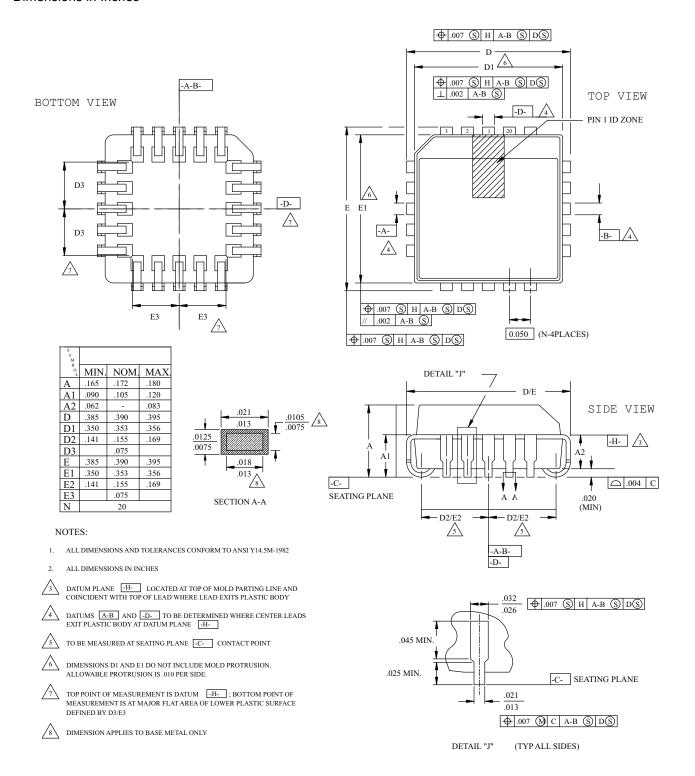
Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong



20-Pin PLCC Package

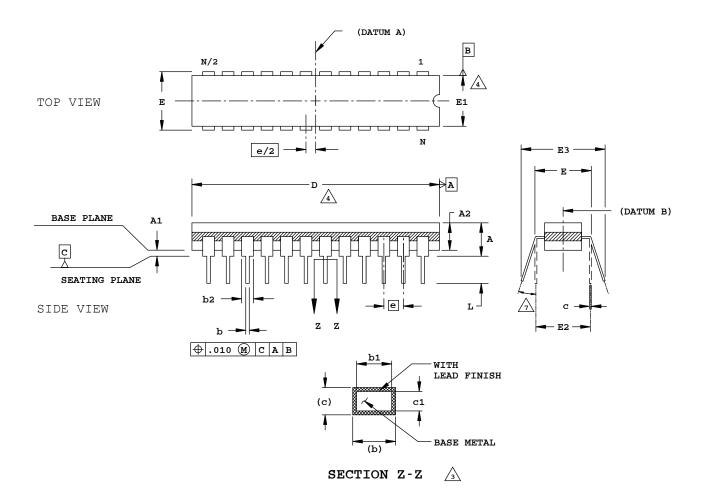
Dimensions in Inches





24-Pin (300-Mil) CERDIP

Dimensions in Inches



NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN INCHES.



MEASUREMENTS TO BE TAKEN AT A MINIMUM OF .060 INCHES FROM THE LEAD TIP.



DIMENSIONS D AND E1 INCLUDE ALLOWANCE FOR GLASS OVERRUN AND MENISCUS, AND LID TO BASE MISMATCH.

- 5. DIMENSIONS A, A1 AND L ARE MEASURED WITH THE PACKAGE SEATED IN JEDEC SEATING PLANE GAUGE GS-003.
- 6. E3 IS TO BE MEASURED AT THE LEAD TIPS.



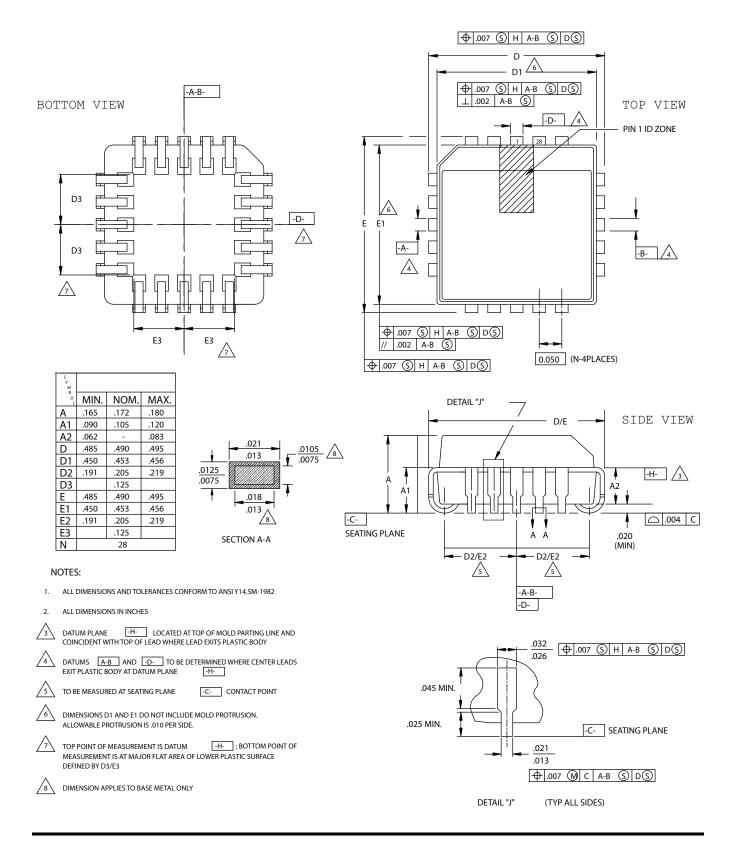
ALLOWED LEAD TIP POSITION RANGE.

S Y M B	INCHES		
o L	MIN.	NOM.	MAX.
A	-	-	.200
A1	.015	-	-
A 2	.140	-	.175
b	.015		.023
b1	.015	.018	.021
b2	.045	-	.065
С	.008	-	.014
c1	.008	.010	.012
D	1.242	1.250	1.270
E	.308		.325
E1	.280	.288	.296
E2	.300 REF		
E 3	.325	-	.410
е	.100 BSC		
L	.125	-	.200
N	24		



28-Pin PLCC Package

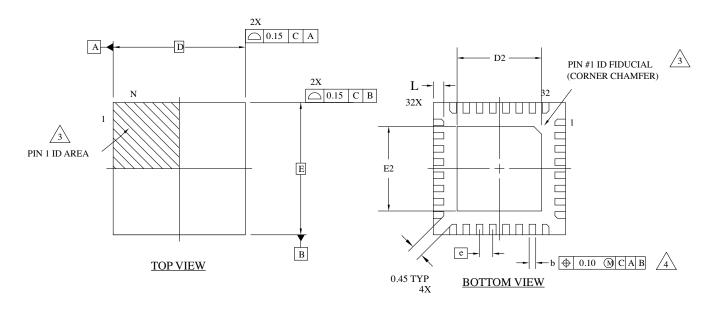
Dimensions in Inches

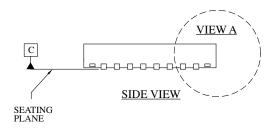


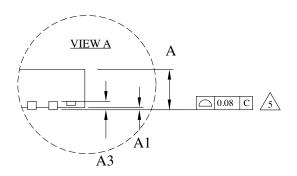


32-Pin QFN Package Option 2: MachXO2™

Dimensions in Millimeters







NOTES: UNLESS OTHERWISE SPECIFIED

- 1. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.

EXACT SHAPE AND SIZE OF THIS FEATURE IS OPTIONAL.

DIMENSION 6 APPLIES TO PLATED
TERMINAL AND IS MEASURED BETWEEN
0.15 AND 0.30 mm FROM TERMINAL TIP.

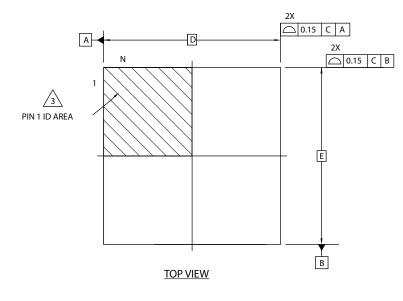
APPLIES TO EXPOSED PORTION OF TERMINALS.

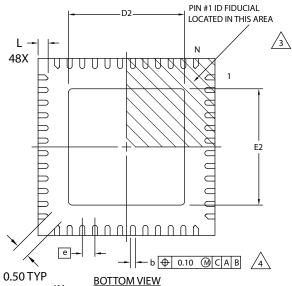
SYMBOL MIN. NOM. MAX. A 0.50 0.55 0.60 A1 0.00 0.02 0.05 A3 0.2 REF D 5.0 BSC D2 3.10 3.20 3.30 E 5.0 BSC E2 3.10 3.20 3.30 b 0.20 0.25 0.30 e 0.50 BSC L 0.35 0.40 0.45				
A1 0.00 0.02 0.05 A3 0.2 REF D 5.0 BSC D2 3.10 3.20 3.30 E 5.0 BSC E2 3.10 3.20 3.30 b 0.20 0.25 0.30 e 0.50 BSC	SYMBOL	MIN.	NOM.	MAX.
A3 0.2 REF D 5.0 BSC D2 3.10 3.20 3.30 E 5.0 BSC E2 3.10 3.20 3.30 b 0.20 0.25 0.30 e 0.50 BSC	A	0.50	0.55	0.60
D 5.0 BSC D2 3.10 3.20 3.30 E 5.0 BSC E2 3.10 3.20 3.30 b 0.20 0.25 0.30 e 0.50 BSC	A1	0.00	0.02	0.05
D2 3.10 3.20 3.30 E 5.0 BSC E2 3.10 3.20 3.30 b 0.20 0.25 0.30 e 0.50 BSC	A3	0.2 REF		
E 5.0 BSC E2 3.10 3.20 3.30 b 0.20 0.25 0.30 e 0.50 BSC	D	5.0 BSC		
E2 3.10 3.20 3.30 b 0.20 0.25 0.30 e 0.50 BSC	D2	3.10	3.20	3.30
b 0.20 0.25 0.30 e 0.50 BSC	Е	5.0 BSC		
e 0.50 BSC	E2	3.10	3.20	3.30
	b	0.20	0.25	0.30
L 0.35 0.40 0.45	e	0.50 BSC		
	L	0.35	0.40	0.45

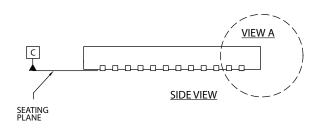


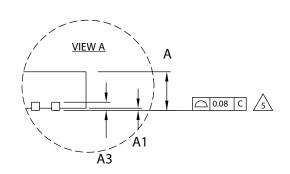
48-Pin QFN Package Option 1

Dimensions in Millimeters









NOTES: UNLESS OTHERWISE SPECIFIED

- 1. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.

 $\underline{ \begin{tabular}{ll} λ & EXACT SHAPE AND SIZE OF THIS \\ FEATURE IS OPTIONAL. \end{tabular}$

DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30 mm FROM TERMINAL TIP.

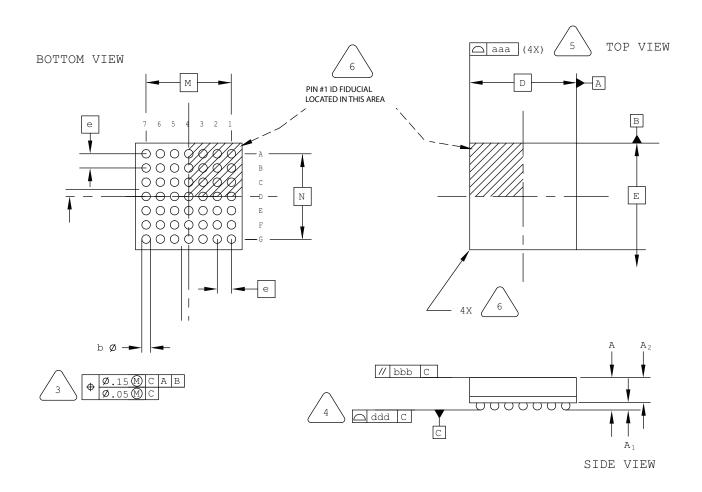
APPLIES TO EXPOSED PORTION OF TERMINALS.

SYMBOL	MIN.	NOM.	MAX.
А	0.80	0.90	1.00
A1	0.00	0.02	0.05
А3	0.2 REF		
D	7.0 BSC		
D2	3.00	-	5.80
E	7.0 BSC		
E2	3.00	-	5.80
b	0.18	0.24	0.30
е	0.50 BSC		
L	0.30	0.40	0.50



49-Ball ucBGA Package

Dimensions in Millimeters



NOTES: UNLESS OTHERWISE SPECIFIED

- 1. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.



DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM C



PRIMARY DATUM C AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.



BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.

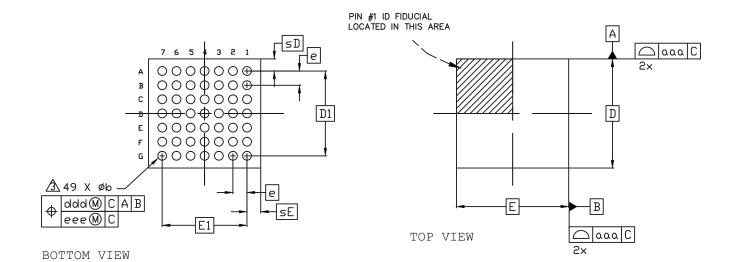


SYMBOL	MIN.	NOM.	MAX.
А	ı	ı	1.00
A1	0.10	-	_
A2	_	-	0.90
D/E	3.00 BSC		
M/N	2.40 BSC		
b	0.20	0.25	0.30
е	0.40 BSC		
aaa	_	_	0.10
bbb	-	-	0.10
ddd	_	_	0.10



49-Ball WLCS Package

Dimensions in Millimeters



M bbb C A A

SIDE VIEW

Notes:

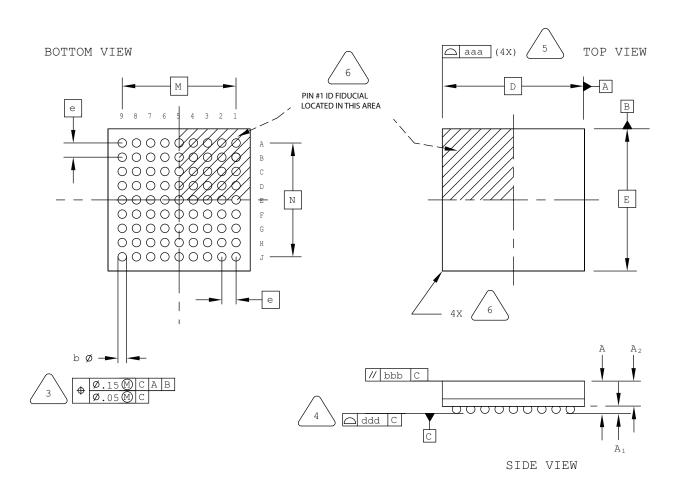
- 1 ALL DIMENSIONS AND TOLERANCE PER ASME Y 14.5M 1994.
- 2 ALL DIMENSIONS ARE IN MILLIMETERS.
- △ DIMENSION "b" IS MEASURED AT THE MAXIMUM BUMP DIAMETER PARALLEL TO PRIMARY DATUM C.
- riangle PRIMARY DATUM C AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BUMPS.

REF.	Min.	Nom.	Max.
A	_		0.600
A1	0.167	0.199	0.232
b	0.239	0.266	0.319
D	3.055	3.106	3.155
E	3.125	3.185	3.225
D1	2	.40 BSC	2
E1	2.40 BSC		
е	0	.40 BSC	
sD	0.353	_	0.383
sE	0.388	-	0.418
aaa	(0.030	
bbb	0.060		
ccc	0.050		
ddd	0.015		
eee	(0.050	
	•		



81-Ball ucBGA Package

Dimensions in Millimeters



NOTES: UNLESS OTHERWISE SPECIFIED

- 1. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.



DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM C



PRIMARY DATUM C AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.



BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.

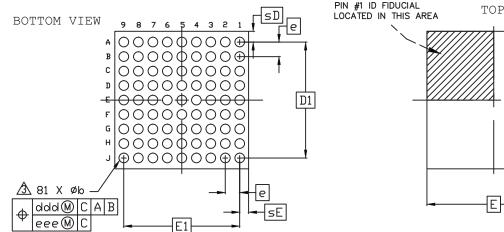


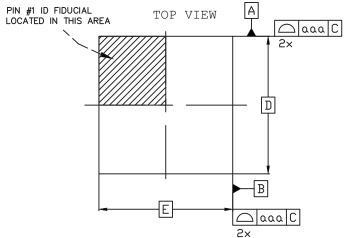
SYMBOL	MIN.	NOM.	MAX.	
А	-	-	1.00	
A1	0.10	_	-	
A2	1	-	0.90	
D/E	4.00 BSC			
M/N	3	3.20 BSC		
b	0.20 0.25		0.30	
е	0	.40 BSC		
aaa	_	_	0.10	
bbb	-	_	0.10	
ddd	-	_	0.10	

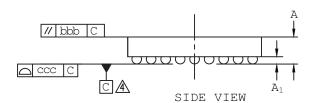


81-Ball WLCS Package

Dimensions in Millimeters







Notes:

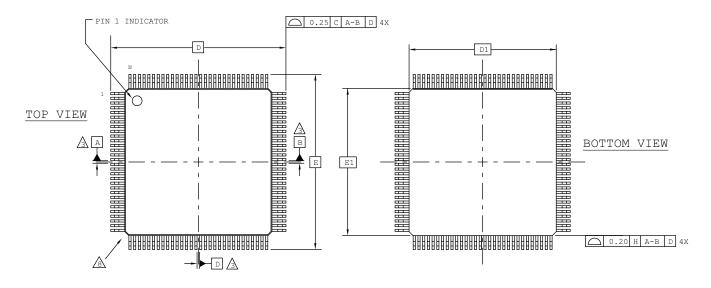
- 1 ALL DIMENSIONS AND TOLERANCE PER ASME Y 14.5M 1994.
- 2 ALL DIMENSIONS ARE IN MILLIMETERS.
- \triangle DIMENSION "b" IS MEASURED AT THE MAXIMUM BUMP DIAMETER PARALLEL TO PRIMARY DATUM $\boxed{\mathbb{C}}$.
- A PRIMARY DATUM C AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BUMPS.

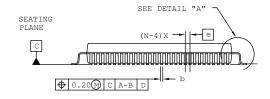
REF.	Min.	Nom.	Max.
A	0.510	0.543	0.567
A1	0.167	0.196	0.225
b	0.239	0.266	0.319
D	3	.797 BS	С
E	3	.693 BS	С
D1	3	.20 BS0	2
E1	3.20 BSC		
е	0	.40 BS0	2
sD	_	0.299	_
sE	_	0.247	-
aaa	0.025		
bbb	0.060		
ccc	0.030		
ddd	0.015		
eee		0.050	

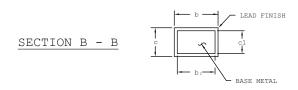


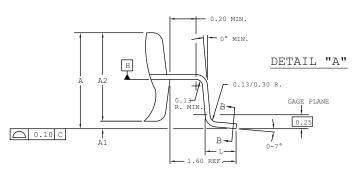
120-Pin PQFP Package

Dimensions in Millimeters









NOTES:

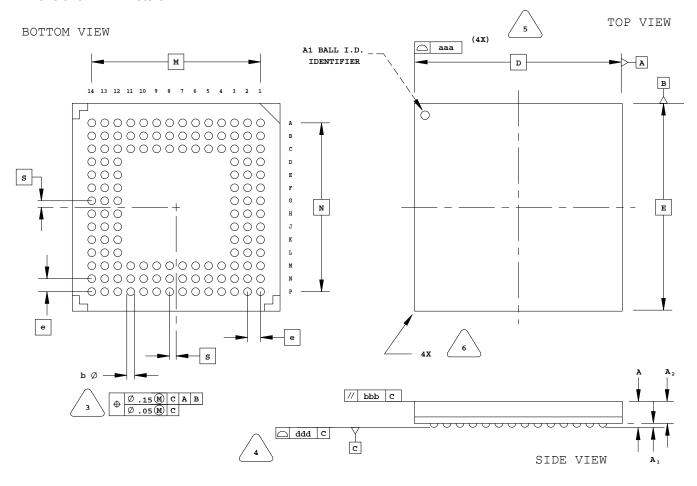
- 1.0 DIMENSIONING AND TOLERANCING PER ANSI Y14.5 1982.
- 2.0 ALL DIMENSIONS ARE IN MILLIMETERS.
- A DATUMS A, B AND D TO BE DETERMINED AT DATUM PLANE H.
- 4.0 DIMENSIONS D1 AND E1 DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE MOLD PROTRUSION IS 0.254 MM ON D1 AND E1 DIMENSIONS.
- 5.0 THE TOP OF PACKAGE MAY BE SMALLER THAN THE BOTTOM OF THE PACKAGE BY 0.15 MM.
- 7.0 A1 IS DEFINED AS THE DISTANCE FROM THE SEATING PLANE TO THE LOWEST POINT ON THE PACKAGE BODY.
- $\stackrel{\textstyle \wedge}{\underline{\mathop{\otimes}}}$ exact shape of each corner is optional.
- SEXACT SHAPE OF EXPOSED HEATSINK IS OPTIONAL.

SYMBOL	MIN.	NOM.	MAX.	
A	-	-	4.10	
A1	0.25	-	0.50	
A2	3.20	3.40	3.60	
D		31.20 BSC	!	
D1		28.00 BSC		
E	31.20 BSC			
E1		28.00 BSC		
L	0.73	0.88	1.03	
N	120			
е	0.80 BSC			
b	0.29	-	0.45	
b1	0.29	0.35	0.41	
С	0.11	-	0.23	
c1	0.11	0.15	0.19	



132-Ball csBGA Package Option 1: MachXO2, MachXO, LatticeXP2™

Dimensions in Millimeters



NOTES: UNLESS OTHERWISE SPECIFIED

- DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.



DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM C



PRIMARY DATUM C AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.



BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.

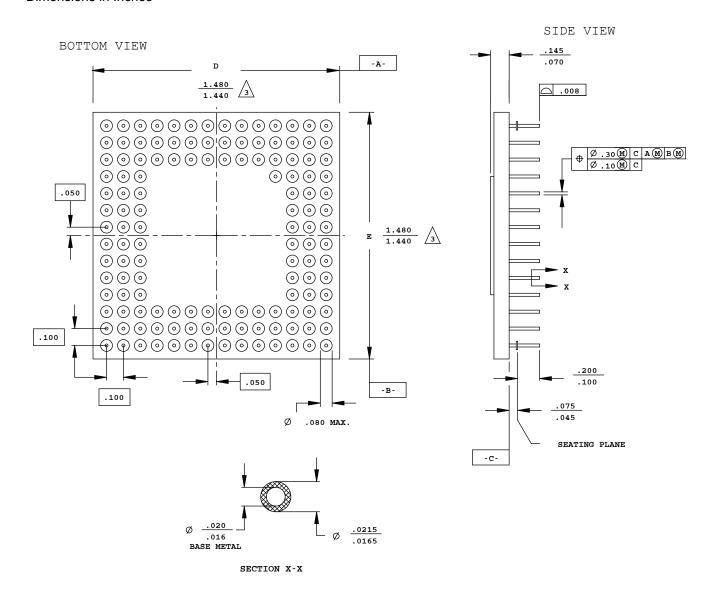


	Г			
SYMBOL	MIN.	NOM.	MAX.	
A	0.90	1.23	1.35	
A1	0.15	-	-	
A2	-	-	1.10	
D/E	8	8.00 BSC		
M/N	6.50 BSC			
s	0.	.25 BSC		
b	0.25	0.35		
е	0.50 BSC			
aaa	-	0.10		
bbb	-	-	0.10	
ddd	-	-	0.08	



133-Pin CPGA Package

Dimensions in Inches



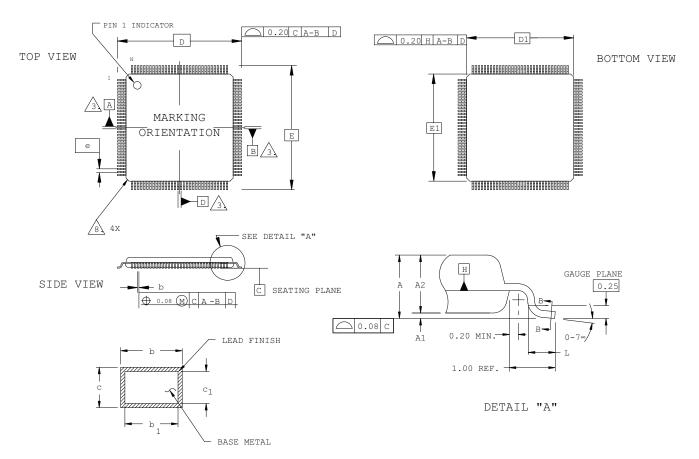
NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN INCHES.
- DIMENSIONS D AND E MAY HAVE MATERIAL PROTRUSION OF
 .006 INCHES MAXIMUM ABOVE THE DIMENSION SHOWN
 NOT TO EXCEED .003 INCHES MAXIMUM PER SIDE.



144-Pin TQFP Package

Dimensions in Millimeters



SECTION B - B

NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5 1982.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.

 $\sqrt{}_3$ DATUMS A, B AND D TO BE DETERMINED AT DATUM PLANE H.

- DIMENSIONS D1 AND E1 DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE MOLD PROTRUSION IS 0.254 MM ON D1 AND E1 DIMENSIONS.
- THE TOP OF PACKAGE MAY BE SMALLER THAN THE BOTTOM OF THE PACKAGE BY 0.15 MM.
- 6. SECTION B-B: $\begin{tabular}{lllll} THESE DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.10 AND 0.25 MM FROM THE LEAD TIP. \\ \end{tabular}$
- 7. Al is defined as the distance from the seating plane to the lowest point on the package body.

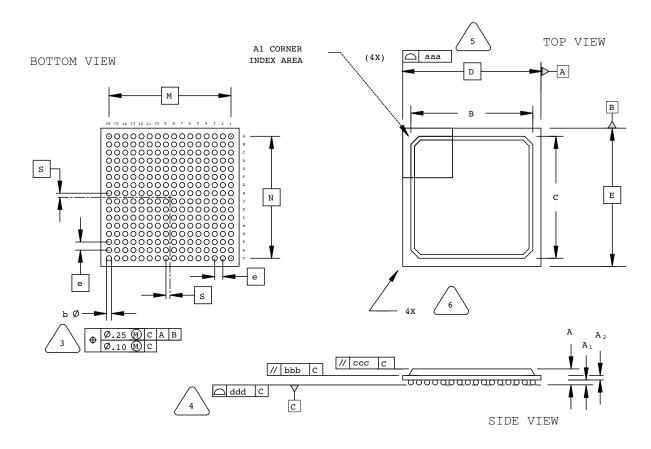
 $\sqrt{8}$ EXACT SHAPE OF EACH CORNER IS OPTIONAL.

SYMBOL	MIN.	NOM.	MAX.	
A	-	-	1.60	
A1	0.05	-	0.15	
A2	1.35	1.40	1.45	
D		22.00 BSC		
D1		20.00 BSC		
Е		22.00 BSC		
E1		20.00 BSC		
L	0.45 0.60		0.75	
N	144			
е		0.50 BSC		
b	0.17 0.22 0.27			
b1	0.17	0.20	0.23	
С	0.09	0.15	0.20	
c1	0.09	0.13	0.16	



256-Ball fpBGA Package

Dimensions in Millimeters



NOTES: UNLESS OTHERWISE SPECIFIED

- 1. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.



DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM C



PRIMARY DATUM C AND SEATING
PLANE ARE DEFINED BY THE SPHERICAL
CROWNS OF THE SOLDER BALLS.



BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.

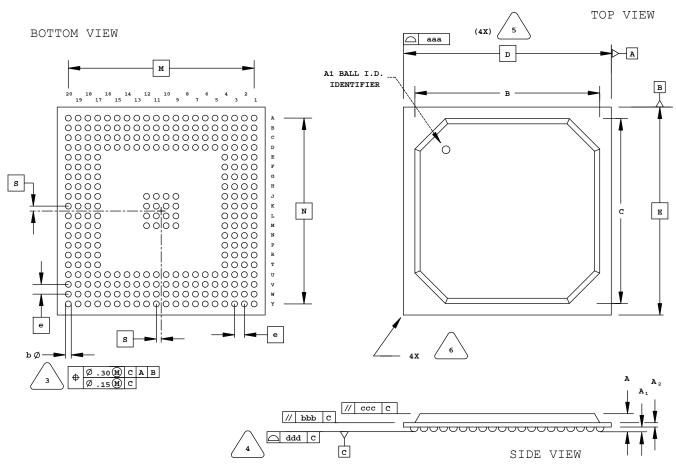


			-
SYMBOL	MIN.	NOM.	MAX.
A	1.30	1.70	2.10
A1	0.30	0.50	0.70
A2	0.30	0.50	0.70
в/с	14.80	15.30	15.80
D/E	17	7.00 BSC	
M/N	15	5.00 BSC	
S	-	0.50 BSC	
b	0.50 0.60		0.70
е	1	.00 BSC	
aaa	-	-	0.20
bbb			0.25
ccc	-	_	0.35
ddd	-	_	0.20



272-Ball BGA Package

Dimensions in Millimeters



NOTES: UNLESS OTHERWISE SPECIFIED

- DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.



DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM C



PRIMARY DATUM C AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.



BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.

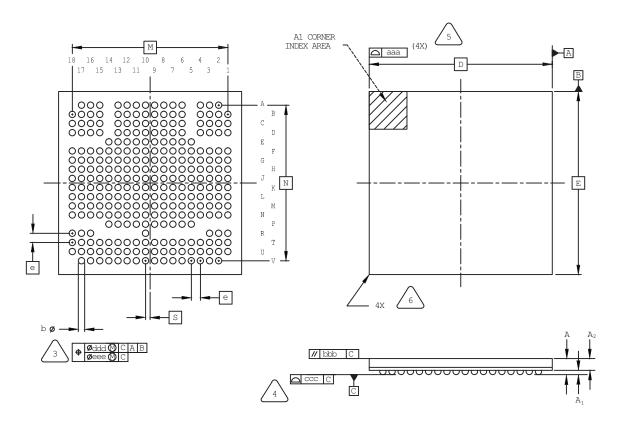


SYMBOL	MIN.	NOM.	MAX.
A	1.90	2.25	2.80
A1	0.50	0.65	0.80
A2	0.28	0.54	0.80
B/C	23.80	24.30	24.80
D/E	27.00 BSC		
M/N	24.13 BSC		
s	0.635 BSC		
b	0.60 0.75 0.90		0.90
е	1.27 BSC		
aaa	-	-	0.20
bbb	-	-	0.25
ccc	-	-	0.35
ddd	-	-	0.20



285-Ball csfBGA Package

Dimensions in Millimeters



NOTES: UNLESS OTHERWISE SPECIFIED

- 1. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.



DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM [C].



PRIMARY DATUM [C] AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.



BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.

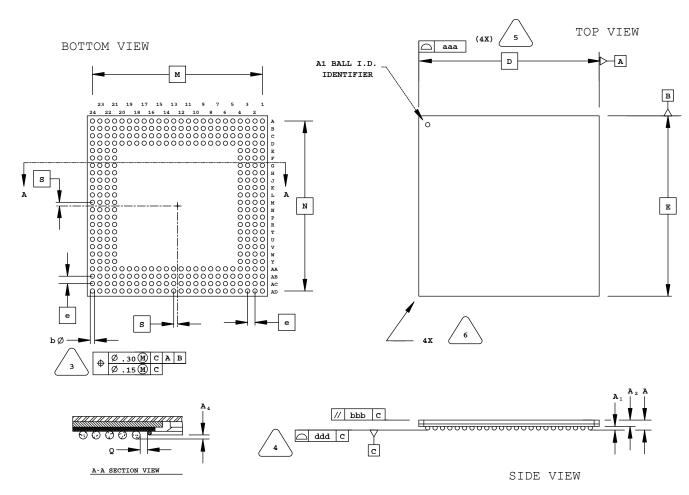


SYMBOL	MIN.	NOM.	MAX.
А	-	-	1.30
A1	0.15	_	_
A2	-	-	1.00
D/E	10.00 BSC		
M/N	8.50 BSC		
S	0.25 BSC		
b	0.25	0.30	0.35
е	0.50 BSC		
aaa	0.10		
bbb	0.10		
ccc	0.08		
ddd	0.15		
eee	0.05		



320-Ball SBGA Package

Dimensions in Millimeters



NOTES: UNLESS OTHERWISE SPECIFIED

- 1. DIMENSIONS AND TOLERANCES
 PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.



DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM C



PRIMARY DATUM C AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.



BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.

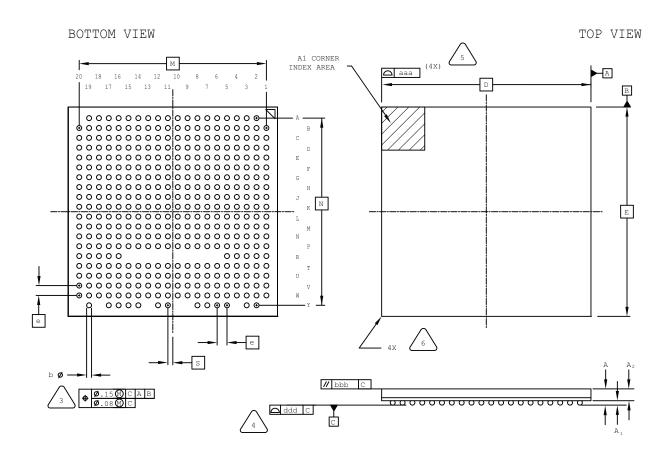


SYMBOL	MIN.	NOM.	MAX.
A	-	-	1.70
A1	0.50	0.65	0.80
A2	0.80	0.90	1.00
D/E	31.00 BSC		
M/N	29.21 BSC		
s	0.635 BSC		
b	0.60	0.75	0.90
е	1.27 BSC		
Q	0.25	-	-
A4	0.10	-	-
aaa	-	-	0.20
bbb	-	-	0.25
ddd	-	-	0.20



381-Ball caBGA Package

Dimensions in Millimeters



NOTES: UNLESS OTHERWISE SPECIFIED

- DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.



DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM C



PRIMARY DATUM C AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.



BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.

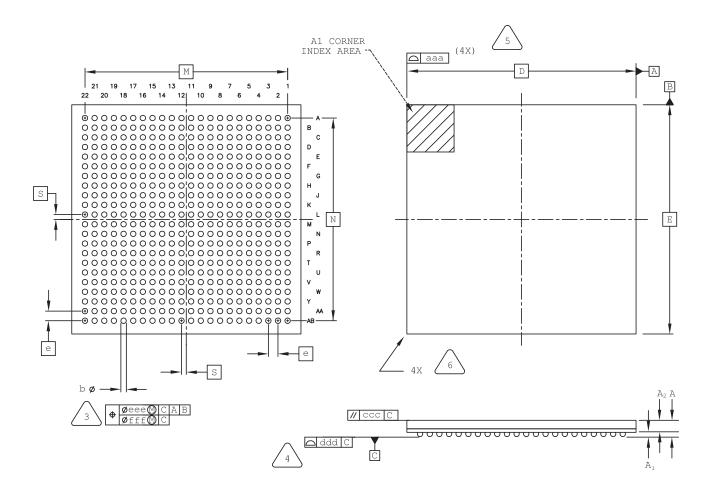


SYMBOL	MIN.	NOM.	MAX.
А	ı	-	1.76
A1	0.25	0.30	0.35
A2	0.80	-	ı
D/E	17.00 BSC		
M/N	15.20 BSC		
S	0.40 BSC		
b	0.35	0.40	0.45
е	0.80 BSC		
aaa	_	-	0.15
bbb	-	-	0.20
ddd	-	_	0.12



484-Ball caBGA Package (19x19 mm Body)

Dimensions in Millimeters



NOTES: UNLESS OTHERWISE SPECIFIED

- 1. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.



DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM C



PRIMARY DATUM C AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.



BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.



EXACT SHAPE AND SIZE OF THIS FEATURE IS OPTIONAL.

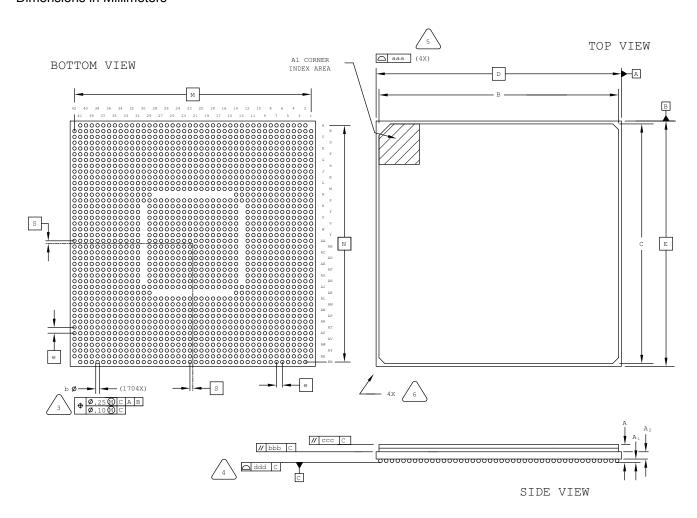
7 JEDEC REFERENCE: MO-275A

SYMBOL	MIN.	NOM.	MAX.
А	-	_	1.70
A1	0.25	-	-
A2	0.65	-	_
D/E	19.0 BSC		
M/N	16.8 BSC		
S	0.40 BSC		
b	0.40	0.45	0.50
е	0.80 BSC		
aaa	_	-	0.15
ccc	_	_	0.20
ddd	_	_	0.20
eee	_	_	0.15
fff	_	_	0.08



1704-Ball Organic fcBGA Package

Dimensions in Millimeters



NOTES: UNLESS OTHERWISE SPECIFIED

- 1. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.



DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM C



PRIMARY DATUM C AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.



BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.



IN.		
	NOM.	MAX.
55	2.90	3.25
.35	0.50	0.65
1.20 REF		
.70	42.00	42.30
42.50 BSC		
42.50 BSC		
0.50 BSC		
50	0.60	0.70
1.00 BSC		
-	-	0.20
_	-	0.25
_	-	0.35
-	-	0.23
	35 1.70 42 42	.35 0.50 1.20 REF .70 42.00 42.50 BSC 42.50 BSC 0.50 BSC 50 0.60